LCCM Series - Chip Common Mode Filter



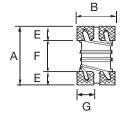
FEATURES

- · Small wire wound chip inductor with ferrite core and 2 common mode lines.
- · Highly effective in noise suppression
- · High common-mode impedance at noise band an low differential mode impedance at signal band factor. There is almost no distortion in high-speed signals.
- Operating temperature -40°C ~ 85°C.

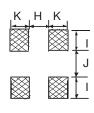
APPLICATIONS

- · EMI suppression for electronic devices.
- USB line in personal computers and peripherals.
- IEEE 1394 line for personal computers, DVC, and STB
- LCD Panels.
- · Low-Voltage Differential Signal (LVDS)

DIMENSIONS

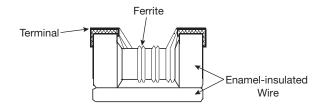






CONSTRUCTION

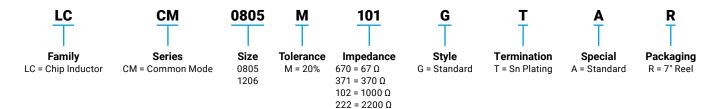




mm (inches)

Туре	Size (inch)	A	В	С	E	F	G	Н	I	J	К	Weight (g) (1000pcs)
LCCM0805	0805	2.00 ± 0.20 (0.079 ± 0.008)	1.20 ± 0.20 (0.047 ± 0.008)	1.20 ± 0.20 (0.047 ± 0.008)	0.45 (0.018)	1.20 (0.047)	0.40 (0.016)	0.80 (0.031)	0.40 (0.016)	0.40 (0.016)	0.90 (0.035)	19
LCCM1206	1206	3.20 ± 0.20 (0.126 ± 0.008)	1.60 ± 0.20 (0.063 ± 0.008)	1.80 ± 0.20 (0.071 ± 0.008)	0.60 (0.024)	2.00 (0.079)	0.60 (0.024)	1.60 (0.063)	0.60 (0.024)	0.40 (0.016)	1.05 (0.041)	53.3

HOW TO ORDER





LCCM Series – Chip Common Mode Filter

ELECTRICAL CHARACTERISTICS

0805

Impedance (Ω)	Tolerance	Test Condition (MHz)	DCR (Ω) max.	IDC (mA) max.	Rated Voltage Vdc (V)	Withstanding Voltage Vdc (V)	Insulation Resistance (MΩ) min.
67	±20% 100		0.25	400	50	125	10
75	±20%	100	0.30	400	50	125	10
90	±20%	100	0.35	330	50	125	10
100	±20%	100	0.35	330	50	125	10
120	±20%	100	0.30	370	50	125	10
160	±20%	100	0.35	350	50	125	10
180	±20%	100	0.35	330	50	125	10
200	±20%	100	0.35	300	50	125	10
220	±20%	100	0.40	300	50	125	10
260	±20%	100	0.40	300	50	125	10
360	±20%	100	0.50	300	50	125	10
370	±20%	100	0.45	280	50	125	10
430	±20%	100	0.55	280	50	125	10
600	±20%	100	0.60	240	50	125	10
750	±20%	100	0.90	220	50	125	10

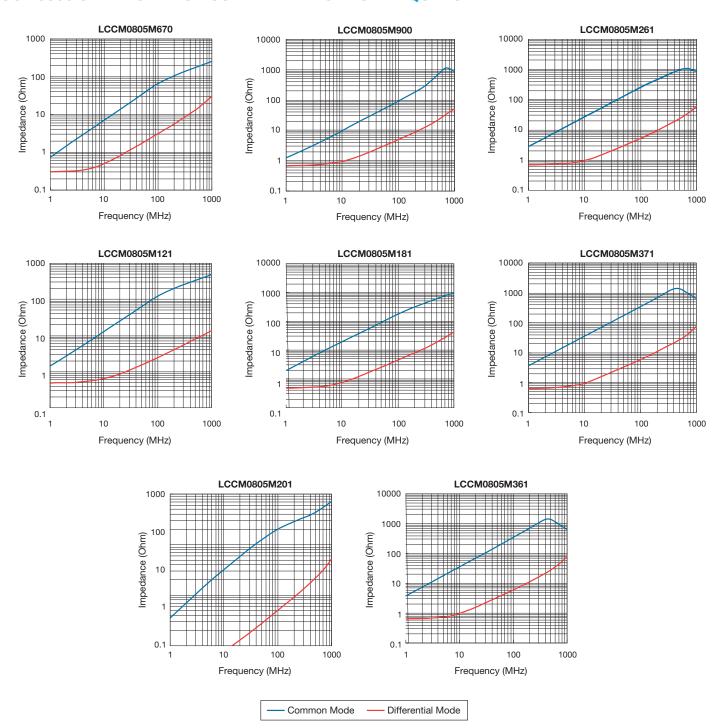
1206

Impedance (Ω)	Tolerance	Test Condition (MHz)	DCR (Ω) max.	IDC (mA) max.	Rated Voltage Vdc (V)	Withstanding Voltage Vdc (V)	Insulation Resistance (MΩ) min.
90	±20%	100	0.30	400	50	125	10
160	±20%	100	0.40	340	50	125	10
260	±20%	100	0.50	310	50	125	10
600	±20%	100	0.80	260	50	125	10
1000	±20%	100	1.00	230	50	125	10
2200	±20%	100	1.20	200	50	125	10





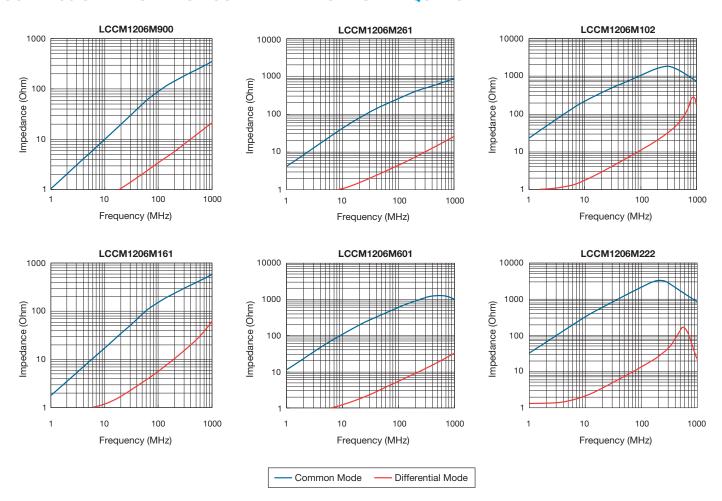
LCCM0805 CHARACTERISTICS - IMPEDANCE VS. FREQUENCY







LCCM1206 CHARACTERISTICS - IMPEDANCE VS. FREQUENCY







ENVIRONMENTAL CHARACTERISTICS

ELECTRICAL PERFORMANCE TEST

Items	Requirement	Test Conditions I Test Methods		
Impedance		LCR Meter HP 4291B		
DC Resistance DCR		Micro-Ohm meter (GOM-801G)		
		Test Voltage: 2.5 Times Rated Voltage		
Withstand Voltage (VDC)	Refer to standard electrical	Testing Time: 60 seconds		
,	characteristic spec.	Charge Current: 0.5mA		
	Component should	Test Voltage: Rated Voltage		
Rated Voltage (VDC)	not be damaged	Testing Time: 1 to 5 seconds		
	_	Charge Current: 1mA		
		Charge Current: 1minute		
Insulation Resistance (I.R)		10M ohm min.		

MECHANICAL PERFORMANCE TEST

Items	Requirement	Test Conditions I Test Methods		
Component Adhesion (Push Test)	Base: 0805 2 Lbs Cover: 0805 1 Lbs Base: 1206 4 Lbs Cover: 1206 2 Lbs	The component should be soldered (232°C ± 5°C for sec.) to tinned copper substrate Applied force gauge to the side of component It must withstand force of 2 or 4 pounds without fails of the component.		
Drop	Component should not be damaged	Drop neight: 100 cm Drop weight: 125 g The component shall be dipped in a melted solder bath at 245 ±5°C for 3 seconds 1. Amplitude: 1.5 m/m 2. Frequency: 10-55-10Hz (1min.)		
Solderability	The terminal should at least be 90% covered with solder			
Vibration Test (Low Frequency)	Component should not be damaged			

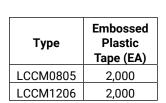
MECHANICAL PERFORMANCE TEST

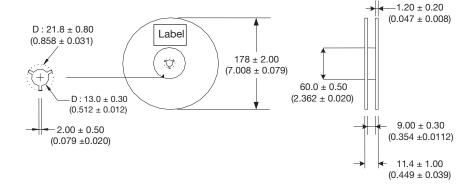
Items	Requirement	Test Conditions I Test Methods			
Low Temperature Storage		Temp: -40 ±2°C Time: 1000±48 Hours Component should be tested after 1 hour at room temperature			
Thermal Shock	Impedance change: Within± 20% Without distinct damage in	Total: 5 Cycles → ROOM TEMP 15 MINS -25 ± 2°C 30 MINS			
High Temperature Storage	appearance	 Temp: 85 ± 2°C Time: 1000 ± 48 Hours Component should be tested after 1 hour at room temperature 			
Humidity		1. Temp: 40 ± 2°C 2. R.H. : 90 - 95% 3. Time: 48 ±2 Hours			
High Temperature Load Life	There should be no evidence of	1. Temp: 85 ± 2°C 2. Time: 96 ± 12 Hours 3. Load: Allowed DC Current 1. Temp: -40 ± 2°C 2. Time: 96 ± 12 Hours 3. Load: Allowed DC Current			
Low Temperature Load Life	short or open circuit				



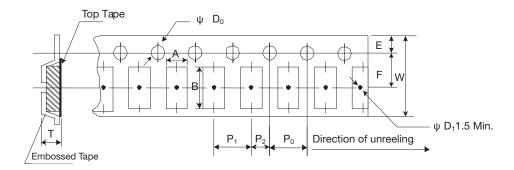


PACKAGING QUANTITY REAL SPECIFICATIONS





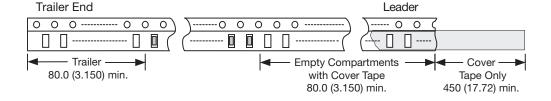
EMBOSSED PLASTIC TAPE SPECIFICATIONS



mm (inches)

Туре	Α	В	W	Е	F	P_{0}	P ₁	P ₂	ΦD_0	Т
LCCM0805	1.40 ± 0.10	2.55 ± 0.05	8.0 ± 0.20	1.75 ± 0.10	3.50 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	1.50 ± 0.10	1.35 ± 0.10
	(0.055 ± 0.004)	(0.100 ± 0.002)	(0.315 ± 0.008)	(0.069 ± 0.004)	(0.138 ± 0.004)	(0.157 ± 0.004)	(0.157 ± 0.004)	(0.079 ± 0.004)	(0.059 ± 0.004)	(0.053 ± 0.004)
LCCM1206	1.90 ± 0.10	3.50 ± 0.05	8.0 ± 0.20	1.75 ± 0.10	3.5 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	1.50 ± 0.10	2.10 ± 0.10
	(0.075 ± 0.004)	(0.138 ± 0.004)	(0.315 ± 0.008)	(0.069 ± 0.004)	(0.138 ± 0.004)	(0.157 ± 0.004)	(0.157 ± 0.004)	(0.079 ± 0.004)	(0.059 ± 0.004)	(0.083 ± 0.004)

LEADER/TAPE



PEEL-OFF FORCE

The force for tearing off cover tape is 0.05 - 0.69 (N) in the arrow direction at the following conditions:

Temperature: 5 - 35°C Humidity: 45 - 85%

Atmospheric pressure: 860 - 1060hpa

